

## OptiMOS™-T Power-Transistor





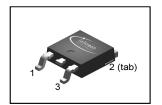
## **Product Summary**

V <sub>DS</sub>	120	V
R <sub>DS(on),max</sub>	31	mΩ
I <sub>D</sub>	30	Α

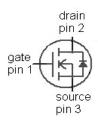
#### **Features**

- OptiMOS™ power MOSFET for automotive applications
- N-channel Enhancement mode
- Automotive AEC Q101 qualified
- MSL1 up to 260°C peak reflow
- 175°C operating temperature
- RoHS compliant
- 100% Avalanche tested

## PG-TO252-3-11



Туре	Package	Marking
IPD30N12S3L-31	PG-TO252-3-11	3N12L31



## **Maximum ratings,** at $T_i$ =25 °C, unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
Continuous drain current	I <sub>D</sub>	T <sub>C</sub> =25°C, V <sub>GS</sub> =10V	30	А
		$T_{\rm C}$ =100°C, $V_{\rm GS}$ =10 $V^{1)}$	20	
Pulsed drain current <sup>1)</sup>	I <sub>D,pulse</sub>	T <sub>C</sub> =25°C	120	1
Avalanche energy, single pulse <sup>1)</sup>	E <sub>AS</sub>	/ <sub>D</sub> =15A	138	mJ
Avalanche current, single pulse	IAS	-	30	А
Gate source voltage <sup>3)</sup>	V <sub>GS</sub>	-	±20	V
Power dissipation	P <sub>tot</sub>	T <sub>C</sub> =25°C	57	w
Operating and storage temperature	$T_{\rm j},T_{\rm stg}$	-	-55 +175	°C



Parameter	Symbol	Conditions	Values		Unit	
			min.	typ.	max.	
Thermal characteristics <sup>1)</sup>						
Thermal resistance, junction - case	R <sub>thJC</sub>	-	-	-	2.6	K/W
SMD version, device on PCB	R <sub>thJA</sub>	minimal footprint	-	-	62	1
		6 cm <sup>2</sup> cooling area <sup>2)</sup>	-	-	40	]

# **Electrical characteristics,** at $T_j$ =25 °C, unless otherwise specified

#### **Static characteristics**

Drain-source breakdown voltage	V <sub>(Br)DSS</sub>	V <sub>GS</sub> =0V, I <sub>D</sub> = 1mA	120	-	-	V
Gate threshold voltage	V <sub>GS(th)</sub>	$V_{\rm DS}=V_{\rm GS}, I_{\rm D}=29\mu{\rm A}$	1.2	1.7	2.4	
Zero gate voltage drain current	I <sub>DSS</sub>	$V_{\rm DS}$ =120V, $V_{\rm GS}$ =0V, $T_{\rm j}$ =25°C	-	0.01	0.1	μA
		$V_{\rm DS}$ =120V, $V_{\rm GS}$ =0V, $T_{\rm j}$ =125°C <sup>1)</sup>	-	1	10	
Gate-source leakage current	I <sub>GSS</sub>	V <sub>GS</sub> =20V, V <sub>DS</sub> =0V	-	-	100	nA
Drain-source on-state resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> =4.5V, I <sub>D</sub> =30A	1	32	42	mΩ
		V <sub>GS</sub> =10 V, I <sub>D</sub> =30 A		26	31	



Parameter	Symbol Conditions		Values			Unit
			min.	typ.	max.	
Dynamic characteristics <sup>1)</sup>						
Input capacitance	C iss		-	1520	1976	pF
Output capacitance	Coss	$V_{GS}$ =0V, $V_{DS}$ =25V, f=1MHz	-	380	494	]
Reverse transfer capacitance	C <sub>rss</sub>		-	45	68	]
Turn-on delay time	t <sub>d(on)</sub>		-	6	-	ns
Rise time	t <sub>r</sub>	V <sub>DD</sub> =20V, V <sub>GS</sub> =10V,	-	4	-	1
Turn-off delay time	t <sub>d(off)</sub>	$I_{\rm D}$ =30A, $R_{\rm G}$ =3.5 $\Omega$	-	18	-	1
Fall time	t <sub>f</sub>		-	3	-	1
Gate Charge Characteristics <sup>1)</sup>						
Gate to source charge	Q <sub>gs</sub>		-	5	7	nC
Gate to drain charge	Q <sub>gd</sub>	V <sub>DD</sub> =96V, I <sub>D</sub> =30A,	-	4	6	
Gate charge total	Q <sub>g</sub>	$V_{\rm GS}$ =0 to 10V	-	24	31	
Gate plateau voltage	V <sub>plateau</sub>		-	3.7	-	V
Reverse Diode					-	
Diode continous forward current <sup>1)</sup>	Is	- T <sub>C</sub> =25°C	-	-	30	Α
Diode pulse current <sup>1)</sup>	I <sub>S,pulse</sub>	7 c-23 C	-	-	120	
Diode forward voltage	V <sub>SD</sub>	V <sub>GS</sub> =0V, I <sub>F</sub> =30A, T <sub>j</sub> =25°C	0.6	1	1.2	V
Reverse recovery time <sup>1)</sup>	t <sub>rr</sub>	$V_R$ =60V, $I_F$ = $I_S$ , $di_F$ / $dt$ =100A/ $\mu$ s	-	72	-	ns
Reverse recovery charge <sup>1)</sup>	Q <sub>rr</sub>		-	150	-	nC

<sup>1)</sup> Defined by design. Not subject to production test.

 $<sup>^{2)}</sup>$  Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm2 (one layer, 70  $\mu m$  thick) copper area for drain connection. PCB is vertical in still air.

<sup>&</sup>lt;sup>3)</sup> -5V to -20V for max. 168 non-consecutive hours

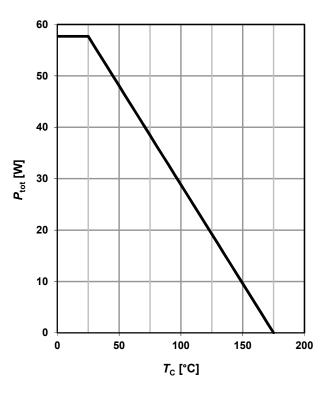


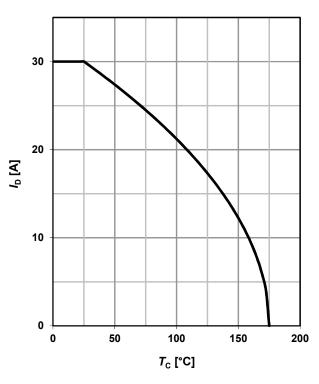
## 1 Power dissipation

$$P_{\text{tot}} = f(T_{\text{C}}); V_{\text{GS}} = 10 \text{ V}$$

# 2 Drain current

$$I_{\rm D} = f(T_{\rm C}); V_{\rm GS} = 10 \text{ V}$$





## 3 Safe operating area

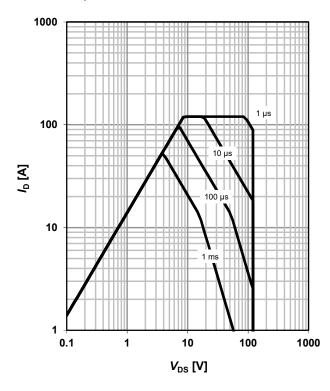
$$I_D = f(V_{DS}); T_C = 25 \,^{\circ}C; D = 0$$

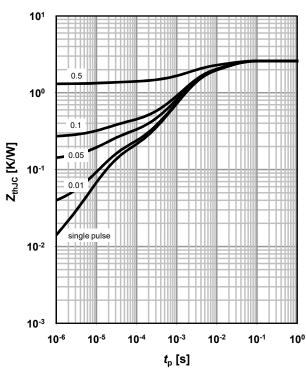
parameter: t<sub>p</sub>

## 4 Max. transient thermal impedance

$$Z_{thJC} = f(t_p)$$

parameter:  $D = t_p/T$ 



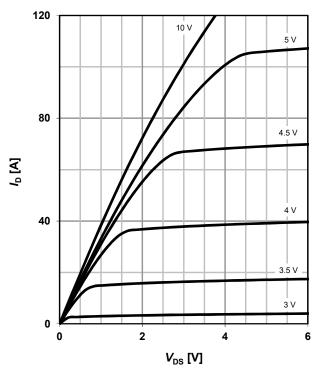




## 5 Typ. output characteristics

 $I_D = f(V_{DS}); T_j = 25 °C$ 

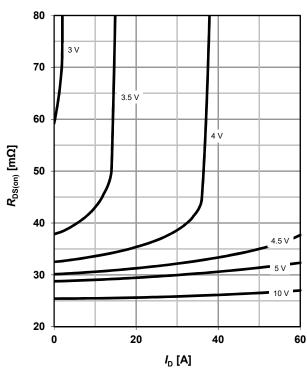
parameter:  $V_{\rm GS}$ 



## 6 Typ. drain-source on-state resistance

 $R_{DS(on)} = f(I_D); T_j = 25 °C$ 

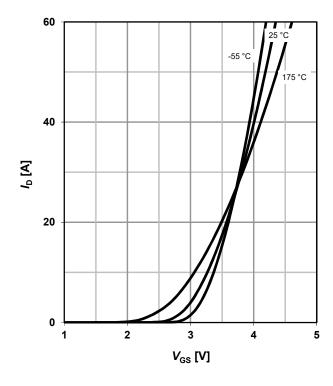
parameter: V<sub>GS</sub>



## 7 Typ. transfer characteristics

 $I_D = f(V_{GS}); V_{DS} = 6V$ 

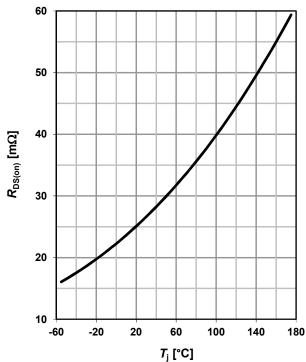
parameter: T<sub>i</sub>



# 8 Typ. drain-source on-state resistance

 $R_{DS(on)} = f(T_j); I_D = 30 \text{ A}; V_{GS} = 10 \text{ V}$ 

 $\alpha = 0.4$ 





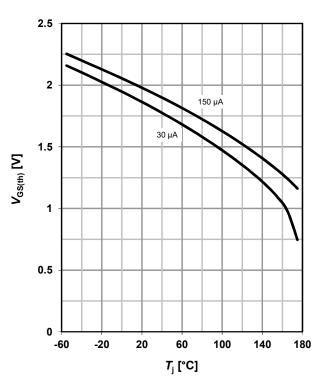
## 9 Typ. gate threshold voltage

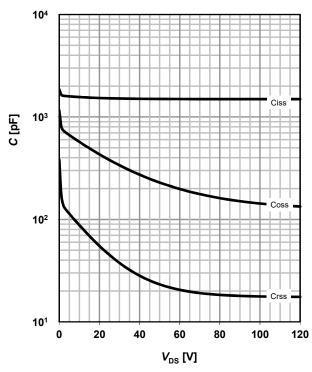
 $V_{GS(th)} = f(T_j); V_{GS} = V_{DS}$ 

parameter:  $I_D$ 

## 10 Typ. capacitances

 $C = f(V_{DS}); V_{GS} = 0 V; f = 1 MHz$ 





## 11 Typical forward diode characteristics

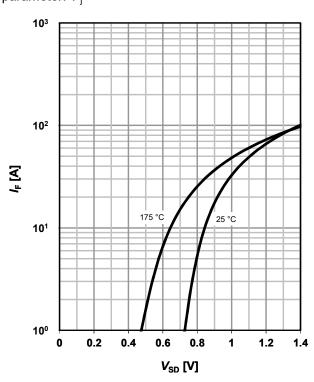
 $I_{\rm F} = f(V_{\rm SD})$ 

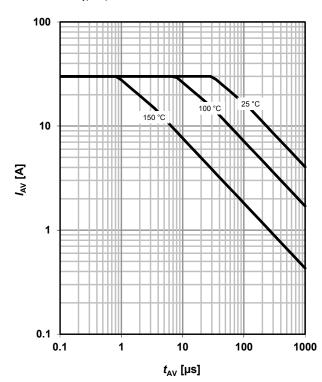
parameter:  $T_{\rm j}$ 

## 12 Typ. avalanche characteristics

 $I_{AS} = f(t_{AV})$ 

parameter:  $T_{j(start)}$ 







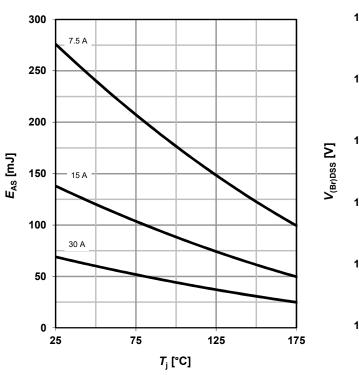
## 13 Typical avalanche energy

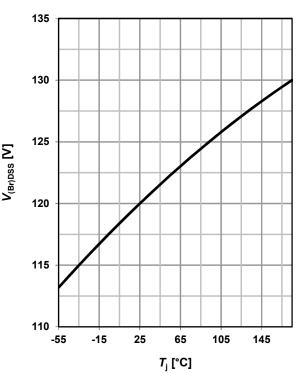
 $E_{AS} = f(T_i)$ 

parameter:  $I_D$ 

## 14 Typ. drain-source breakdown voltage

$$V_{(Br)DSS} = f(T_j); I_D = 1 \text{ mA}$$

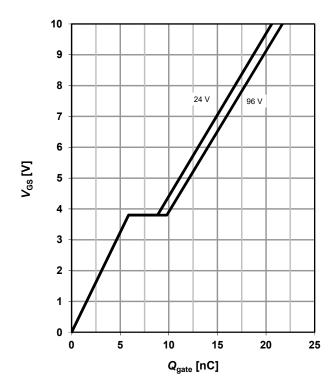




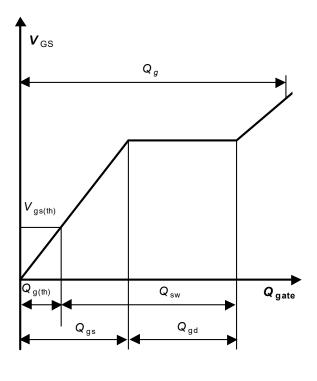
## 15 Typ. gate charge

 $V_{\rm GS}$  = f( $Q_{\rm gate}$ );  $I_{\rm D}$  = 30 A pulsed

parameter:  $V_{\rm DD}$ 



## 16 Gate charge waveforms





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## Revision History

Version	Date	Changes		
Revision 1.0	2016-06-20	Final Data Sheet		
Revision 1.1	2023-06-15	Diagram 8 Typ. drain-source on- state resistance: used α value clarified		
Revision 1.1	2023-06-15	Ratings of V <sub>GS</sub> refined in footnote <sup>3)</sup>		
Revision 1.1	2023-06-15	Corrected diagram 10 typical capacitances		